

Electronic Patent Application Fee Transmittal

Application Number:	10551809			
Filing Date:	30-Sep-2005			
Title of Invention:	METHOD OF FIXING LOW-MOLECULAR COMPOUND TO SOLID-PHASE SUPPORT			
First Named Inventor/Applicant Name:	Hiroyuki Osada			
Filer:	MaryAnne Armstrong/Christine Prucker			
Attorney Docket Number:	3749-0106PUS1			
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U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1510	1510
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
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Printed copy of patent - no color	8001	4	3	12
Total in USD (\$)				1822